

### ECMF06-6HSM16

# Common mode filter with ESD protection for high speed serial interface

Datasheet - production data

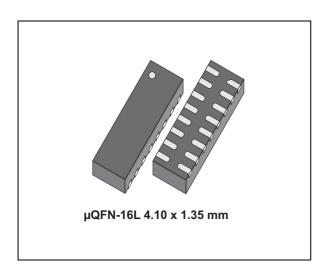
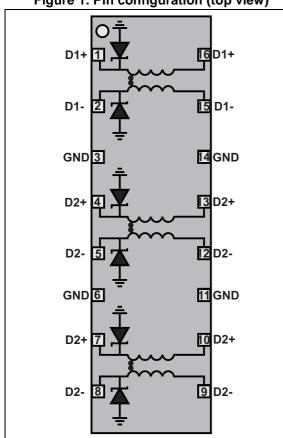


Figure 1. Pin configuration (top view)



#### **Features**

- Very large differential bandwidth to comply with HDMI Full HD, MIPI, USB2.0, USB3.0, Display Port and other high speed serial interfaces
- Provides -20 dB attenuation at 700 MHz in LTE bands
- High common mode attenuation: -25 dB between 800 MHz - 900 MHz
- Very low PCB space consumption
- Thin package: 0.55 mm max.
- Lead-free package
- High reduction of parasitic elements through integration.

#### Complies with the following standards:

- IEC 61000-4-2 level 4:
  - ±15 kV (air discharge)
  - ±8 kV (contact discharge)

### **Applications**

- Mobile phones
- Notebook, laptop
- Portable devices
- PND

### **Description**

This device is a highly integrated common mode filter designed to suppress EMI/RFI common mode noise on high speed differential serial buses like HDMI Full HD, MIPI, Display Port and other high speed serial interfaces. The device has a very large differential bandwidth to comply with these standards. The device can protect and filter 3 differential lanes.

Characteristics ECMF06-6HSM16

### 1 Characteristics

Table 1. Absolute maximum ratings ( $T_{amb} = 25$  °C)

Symbol		Value	Unit	
V <sub>PP</sub>	Peak pulse voltage IEC 61000-4-2 Contact discharge (connector side) Air discharge (connector side)		8 16	kV
I <sub>DC</sub>	Maximum DC current	100	mA	
T <sub>op</sub>	Operating temperature r	-40 to +85	°C	
Tj	Maximum junction temp	125	°C	
T <sub>stg</sub>	Storage temperature ran	- 55 to +150	°C	

Figure 2. Electrical characteristics (definitions)

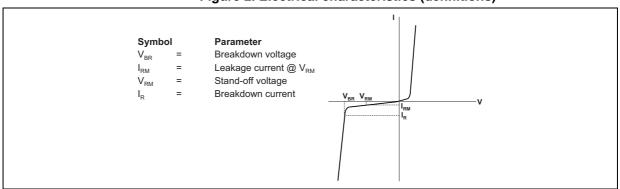


Table 2. Electrical characteristics (T<sub>amb</sub> = 25 °C)

Symbol	Test conditions	Min.	Тур.	Max.	Unit
$V_{BR}$	I <sub>R</sub> = 1 mA	6			V
I <sub>RM</sub>	V <sub>RM</sub> = 3 V per line			100	nA
R <sub>DC</sub>	DC serial resistance		5		Ω

Table 3. Pin description

Table 5.1 III description							
Pin number	Description	Pin number	Description	Pin number	Description	Pin number	Description
1	D1+ to connector	5	D2- to connector	9	D3- to IC	13	D2+ to IC
2	D1- to connector	6	GND	10	D3+ to IC	14	GND
3	GND	7	D3+ to connector	11	GND	15	D1- to IC
4	D2+ to connector	8	D3- to connector	12	D2- to IC	16	D1+ to IC

ECMF06-6HSM16 Characteristics

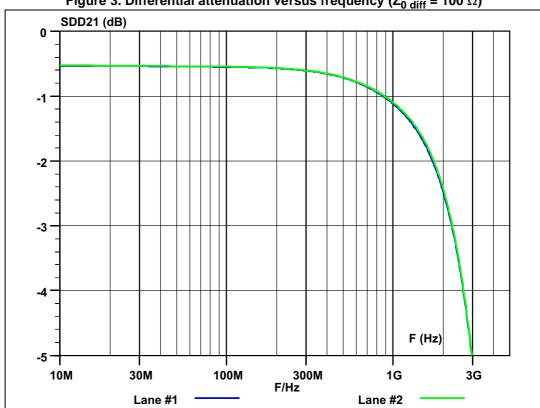
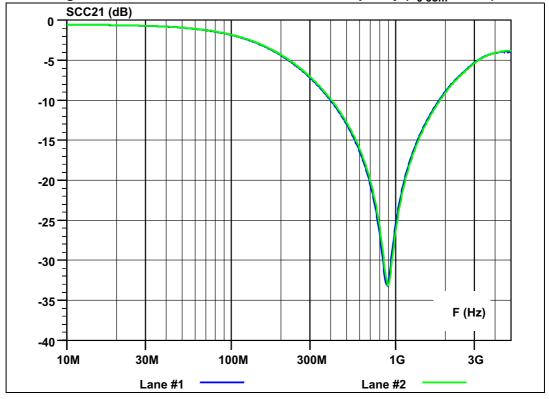


Figure 3. Differential attenuation versus frequency ( $Z_{0 \text{ diff}}$  = 100  $\Omega$ )





Characteristics ECMF06-6HSM16

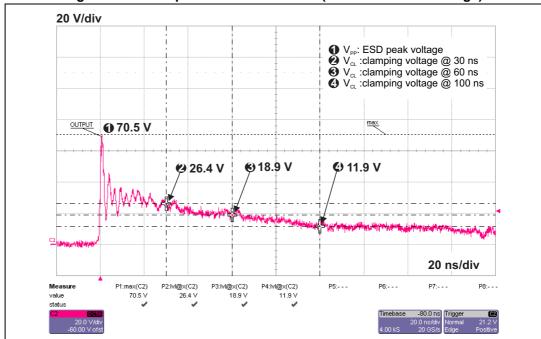
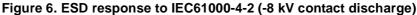
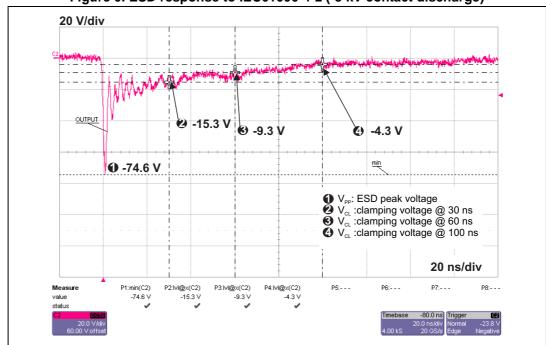


Figure 5. ESD response to IEC61000-4-2 (+8 kV contact discharge)

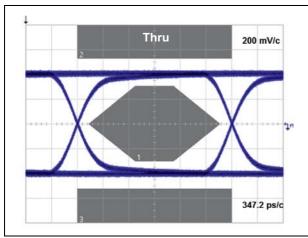




ECMF06-6HSM16 Characteristics

Figure 7. USB2.0 480 Mbps eye diagram without device

Figure 8. USB2.0 480 Mbps eye diagram with device



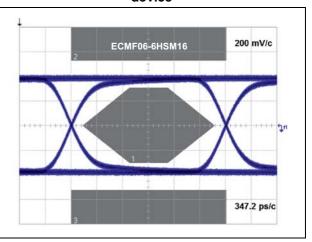
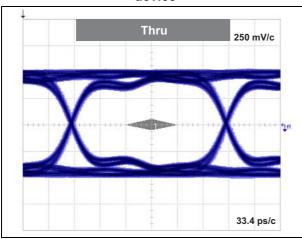


Figure 9. USB3.0 5 Gbps eye diagram without device

Figure 10. USB3.0 5 Gbps eye diagram with device



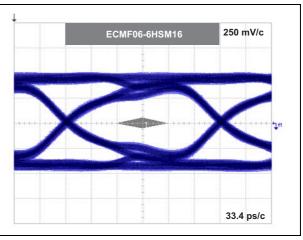
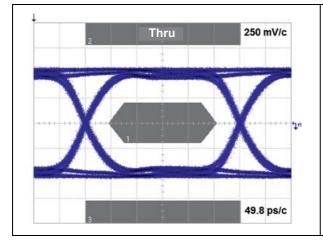
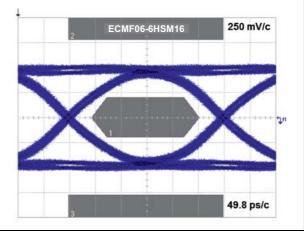


Figure 11. HDMI 3.35 Gbps eye diagram without device

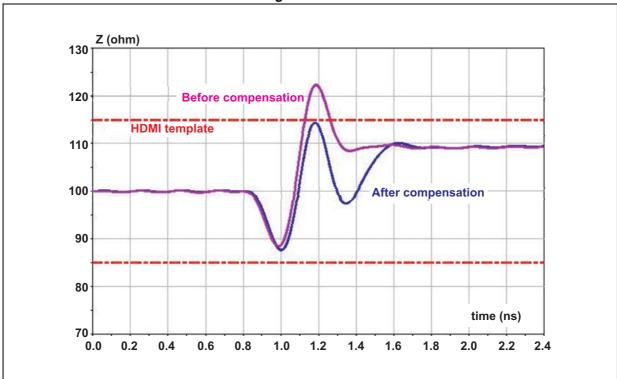
Figure 12. HDMI 3.35 Gbps eye diagram with device





Characteristics ECMF06-6HSM16

Figure 13. TDR



# 2 Application information

mobile industry processor interface MIPI transceiver Application baseband DON DON GND D1P D1P Clock ECMF02 D1N D1N GND GND CLKP CLKP CLKP HDMI2C1-6C1

Figure 14. HDMI schematic

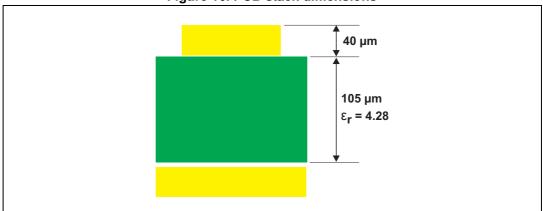
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#### **PCB** layout recommendations 3

Connector Host 5000 μm Pad layout 350 µm 350 µm Differential  $(Z_0 = 100 \Omega)$ 330 μm‡ **Differential**  $(Z_0 = 100 \Omega)$ 

Figure 15. PCB layout recommendations





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## 4 Package information

- Epoxy meets UL94, V0
- Lead-free package

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: <a href="https://www.st.com">www.st.com</a>. ECOPACK<sup>®</sup> is an ST trademark.

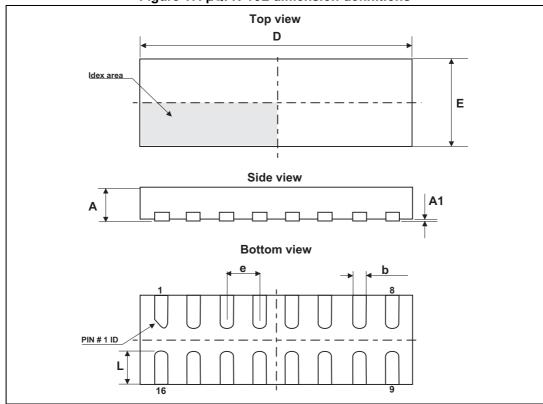


Figure 17. µQFN-16L dimension definitions

Table 4. µQFN-16L dimension values

	Dimensions						
Ref.		Millimeters		Inches			
	Min.	Тур.	Max.	Min.	Тур.	Max.	
А	0.45	0.50	0.55	0.018	0.020	0.022	
A1	0.00	0.02	0.05	0.00	0.0008	0.002	
b	0.15	0.20	0.25	0.006	0.008	0.010	
D		4.10			0.161		
Е		1.35			0.053		
е		0.50			0.020		
L	0.40	0.50	0.60	0.016	0.020	0.024	

Package information ECMF06-6HSM16

Figure 18. Footprint

Figure 19. Marking

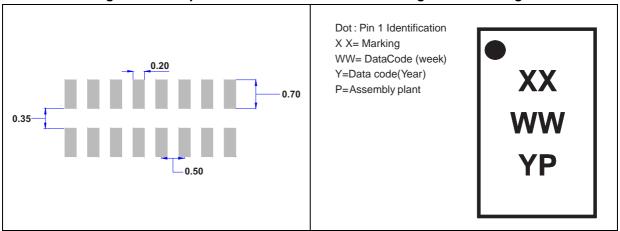
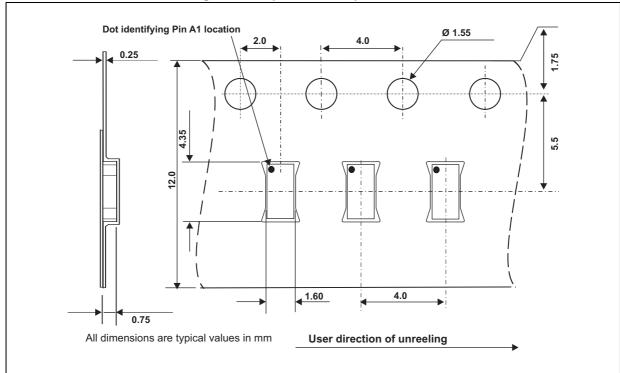
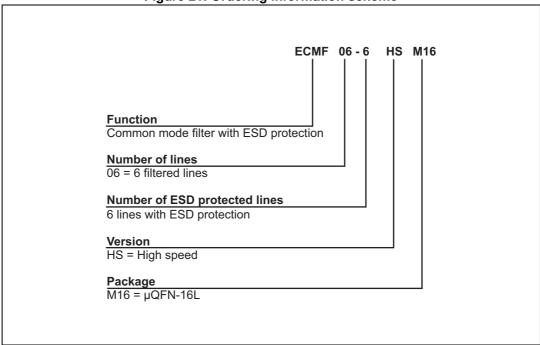


Figure 20. Tape and reel specifications



# 5 Ordering information

Figure 21. Ordering information scheme



**Table 5. Ordering information** 

Order code	Marking	Package	Weight	Base qty	Delivery mode
ECMF06-6HSM16	KL	μQFN-16L	7.76 mg	3000	Tape and reel

# 6 Revision history

Table 6. Document revision history

Date	Revision	Changes
03-Oct-2013	1	Initial release.

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